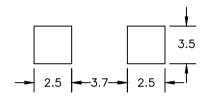
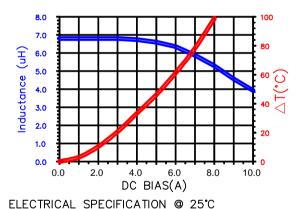
## MGV06036R8M-10

## PHYSICAL DIMENSIONS:

Α	7.30	±	0.50
В	6.70	±	0.30
С	3.00	±	0.30
D	2.90	±	0.30
Ε	1.60	$\pm$	0.50

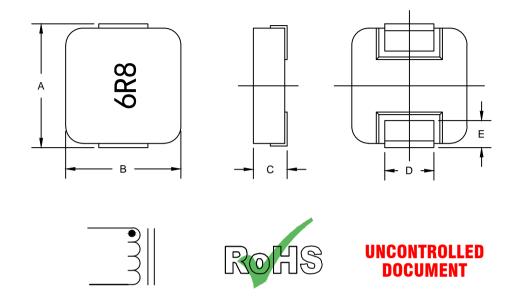
## LAND PATTERNS FOR REFLOW SOLDERING





	Min	Norm	Max
INDUCTANCE (uH)			
L @ 100 KHz/0.25V	5.44	6.80	8.16
± 20%			
DCR $(\Omega)$			0.060

Saturation Current <sup>3</sup> Isat (A)	8.00
Temperature Rise Current Irms <sup>4</sup> (A)	4.50



NOTES: UNLESS OTHERWISE SPECIFIED

- 1.COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2.OPERATION TEMPERATURE RANGE: -40°C~+125°C (INCLUDING SELF-HEATING).
- 3.DEFINITION OF SATURATION CURRENT (ISAT): DC CURRENT AT WHICH THE INDUCTANCE DROPS  $\leq 25\%$  FROM ITS VALUE WITHOUT CURRENT (Ta=25 $\pm$ 5°C).
- 4.DEFINITION OF TEMPERATURE RISE CURRENT (IRMS): DC CURRENT THAT CAUSES THE TEMPERATURE RISE ( $\Delta T \leq 40^{\circ}$ C) FROM 25°C AMBIENT.

	DIMENSIONS ARE IN mm.			This print is the property of Laird					
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L					copies shall be made without the written consent of Laird Tech. All				
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ı					PROJECT/PART NUMBER:	REV	PART TY		DRAWN BY:
ı	С	UPDATE LOGO	04/22/15	QIU	MGV06036R8M-10	C		WER CTOR	QIU
	₩	CHANGE NOTE 2.3.4	09/24/12	QIU	DATE: 06/27/12	CALE: N	TS	SHEET:	
ſ	Α	ORIGINAL DRAFT	06/27/12	QIU	, ,	DOL #	13		
	REV	DESCRIPTION	DATE	INT		#	-	1	of 1